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Dual N-Channel PowerTrench[®] MOSFET Q1: 30 V, 13 A, 20.0 m Ω Q2: 30 V, 22 A, 11.2 m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 20.0 m Ω at V_{GS} = 10 V, I_D = 10.1 A
- Max $r_{DS(on)}$ = 30.0 m Ω at V_{GS} = 4.5 V, I_D = 7.5 A

Q2: N-Channel

- Max $r_{DS(on)}$ = 11.2 m Ω at V_{GS} = 10 V, I_D = 12.4 A
- Max $r_{DS(on)}$ = 14.2 m Ω at V_{GS} = 4.5 V, I_D = 10.9 A
- Pinout optimized for simple PCB design
- Thermally efficient dual Power 56 Package
- RoHS Compliant



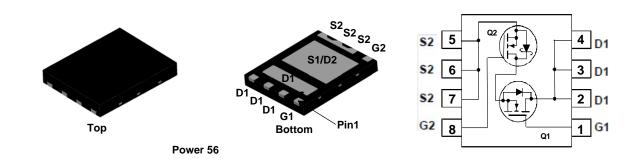
General Description

This device includes two specialized MOSFETs in a unique dual Power 56 package. It is designed to provide an optimal synchronous buck power stage in terms of efficiency and PCB utilization. The low switching loss "High Side" MOSFET is complementory by a low conduction loss "Low Side" SyncFET.

Applications

Synchronous Buck Converter for:

- Notebook System Power
- General Purpose Point of Load



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V _{DS}	Drain to Source Voltage		30	30	V
V _{GS}	Gate to Source Voltage	(Note 3)	±20	±20	V
	Drain Current -Continuous	T _C = 25 °C	13	22	
I _D	-Continuous	T _A = 25 °C	10.1	12.4	А
	-Pulsed		27	45	
E _{AS}	Single Pulse Avalanche Energy	(Note 4)	9	21	mJ
P _D	Power Dissipation for Single Operation	T _A = 25°C	2.2 ^{1a}	2.5 ^{1b}	W
	Power Dissipation for Single Operation	T _A = 25°C	1.0 ^{1c}	1.0 ^{1d}	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	57 ^{1a}	50 ^{1b}	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	125 ^{1c}	120 ^{1d}	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7620S	FDMS7620S	Power 56	13 "	12 mm	3000 units

May 2014

FDMS7620S Dual I
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I-Channel Power
rTrench [®] Mo
MOSFET

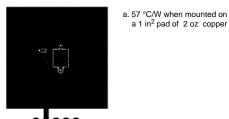
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	octeristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, V_{GS} = 0 \ V$ $I_D = 1 \ mA, V_{GS} = 0 \ V$	Q1 Q2	30 30			V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C $I_D = 10 \ m$ A, referenced to 25°C	Q1 Q2		19 19		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$	Q1 Q2			1 500	μΑ
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20$ V, $V_{DS} = 0$ V	Q1 Q2			100 100	nA nA
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ $V_{GS} = V_{DS}$, $I_D = 1 \ mA$	Q1 Q2	1.0 1.0	2.2 2.0	3.0 3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C $I_D = 10 \ m$ A, referenced to 25°C	Q1 Q2		-6 -5		mV/°C
-	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10.1 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$	Q1		15.2 22.7 18.7	20.0 30.0 22.5	mΩ
r _{DS(on)}			Q2		8.3 10.5 8.9	11.2 14.2 15.1	1115.2
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V, I_D = 10.1 A$ $V_{DD} = 5 V, I_D = 12.4 A$	Q1 Q2		22 53		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance		Q1 Q2		457 1050	608 1400	pF
C _{oss}	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHZ$	Q1 Q2		167 358	222 477	pF
C _{rss}	Reverse Transfer Capacitance		Q1 Q2		22 35	31 49	pF
R _g	Gate Resistance		Q1 Q2	0.2 0.2	1.6 1.2	4.4 3.5	Ω
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time	Q1	Q1 Q2		5.2 6.6	10 14	ns

t _{d(on)}	Turn-On Delay Time	Q1 V _{DD} = 15 V, I _D = 10.1 A, R _{GEN} = 6 Ω ⁻		Q1 Q2	5.2 6.6	10 14	ns
t _r	Rise Time			Q1 Q2	1.2 1.8	10 10	ns
t _{d(off)}	Turn-Off Delay Time	Q2 V _{DD} = 15 V, I _D = 12.4 A, R _{GEN} = 6 Ω		Q1 Q2	11.9 17.4	22 32	ns
t _f	Fall Time			Q1 Q2	1.4 1.5	10 10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0V$ to 10 V Q1	Q1 Q2	7.2 15.6	11 23	nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0V \text{ to } 5 \text{ V}$	V _{DD} = 15 V, I _D = 10.1 A	Q1 Q2	3.8 7.9	6 12	nC
Q _{gs}	Gate to Source Charge	Q2	Q1 Q2	1.6 3.2		nC	
Q _{gd}	Gate to Drain "Miller" Charge		V _{DD} = 15 V, I _D = 12.4 A		1.1 1.6		nC

Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units
Drain-Sou	Irce Diode Characteristics							
V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 10.1 A$ $V_{GS} = 0 V, I_S = 12.4 A$	(Note 2) (Note 2)	Q1 Q2		0.90 0.83	1.2 1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 10.1 A, di/dt = 100 A/s		Q1 Q2		16 18	28 32	ns
Q _{rr}	Reverse Recovery Charge	Q2 $I_F = 12.4 \text{ A, di/dt} = 300 \text{ A/s}$		Q1 Q2		4 13	10 23	nC

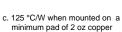
Notes:

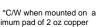
1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.













d. 120 °C/W when mounted on a minimum pad of 2 oz copper

b. 50 °C/W when mounted on

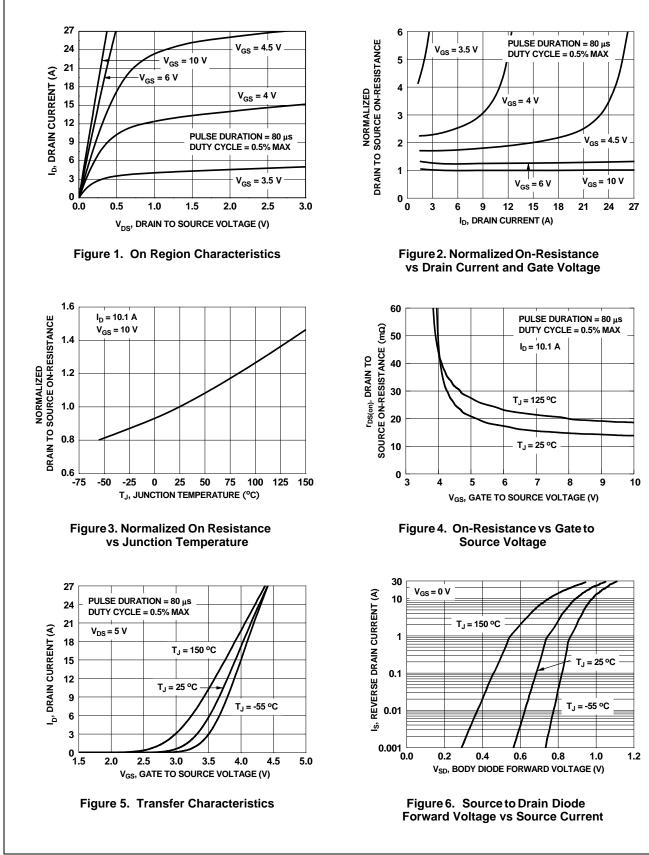
a 1 in² pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 $\ \mu\text{s},$ Duty cycle < 2.0%.

3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.

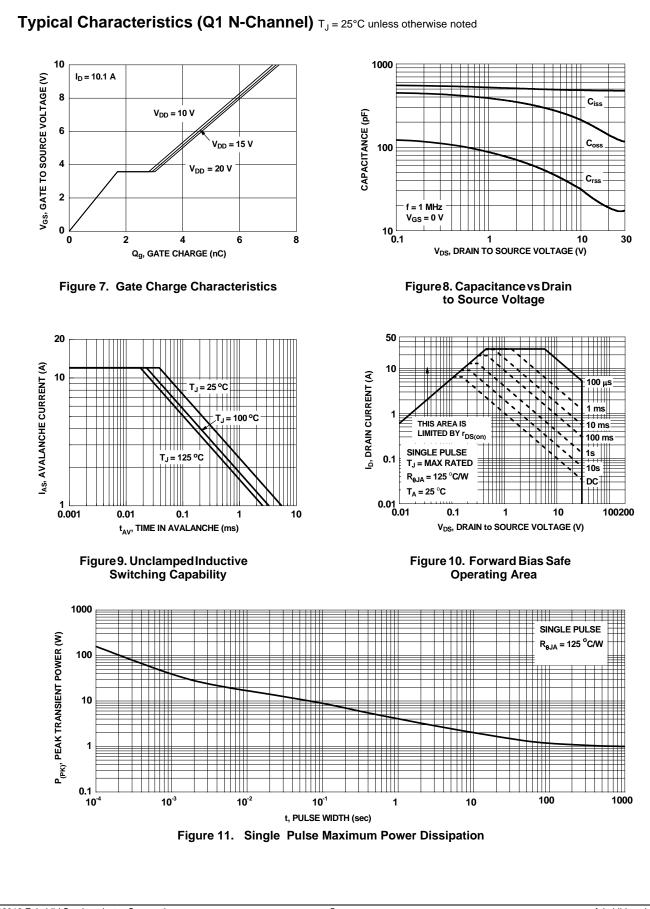
4. Q1: E_{AS} of 9 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 8 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 12 A.

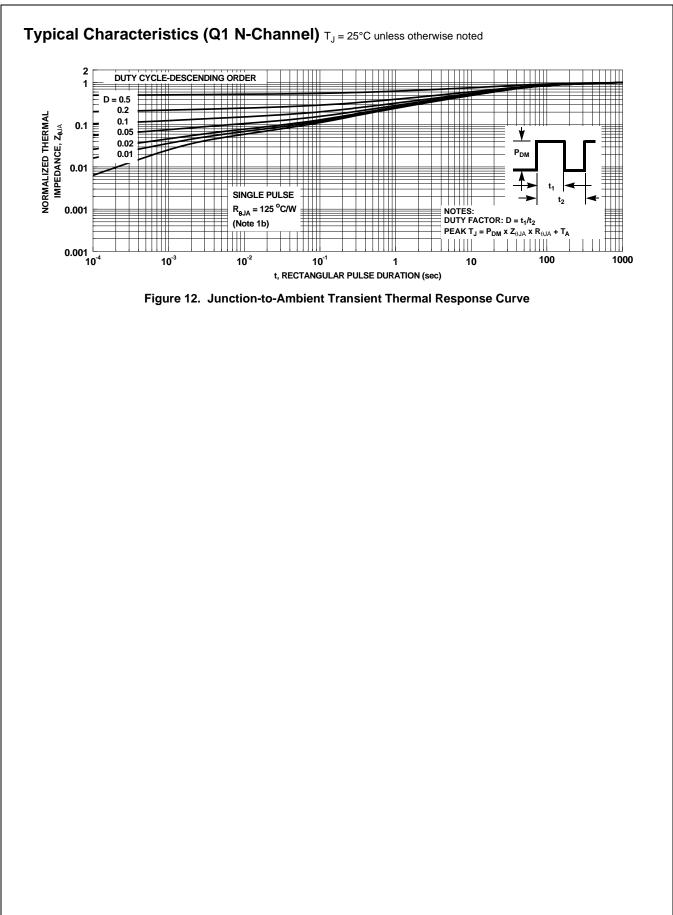
Q2: E_{AS} of 21 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 12 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 18 A.

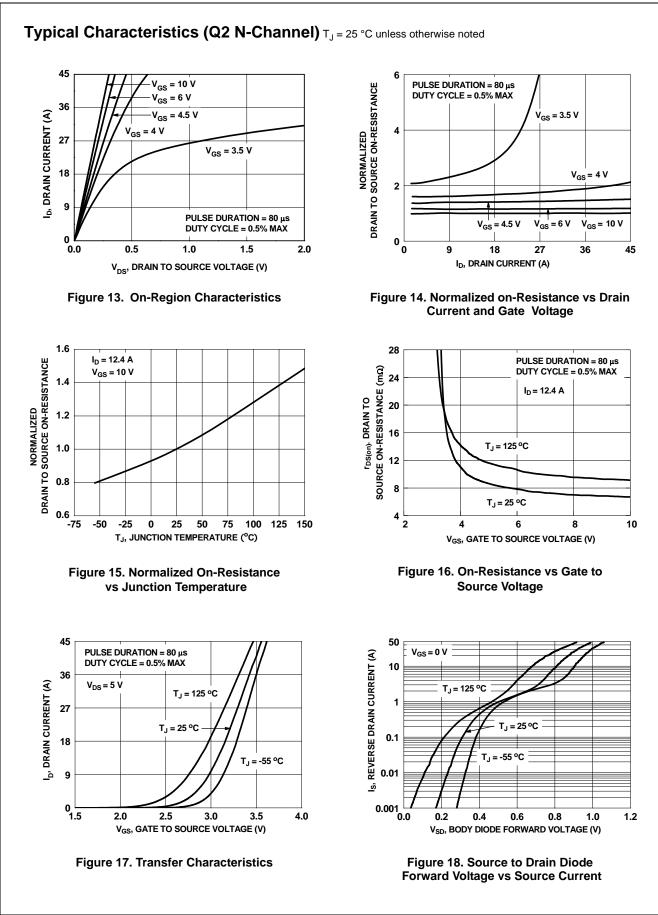


Typical Characteristics (Q1 N-Channel) T_J = 25°C unless otherwise noted

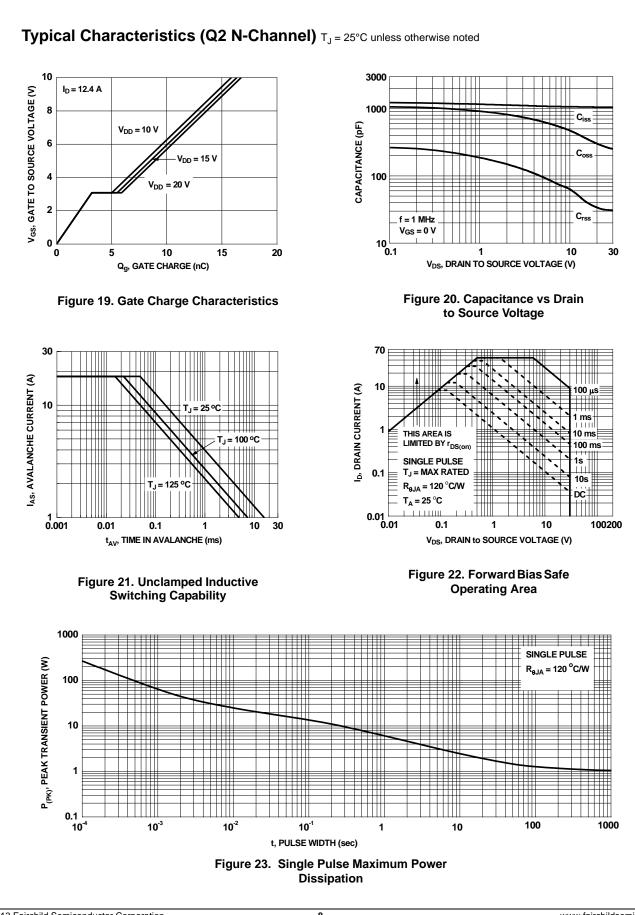


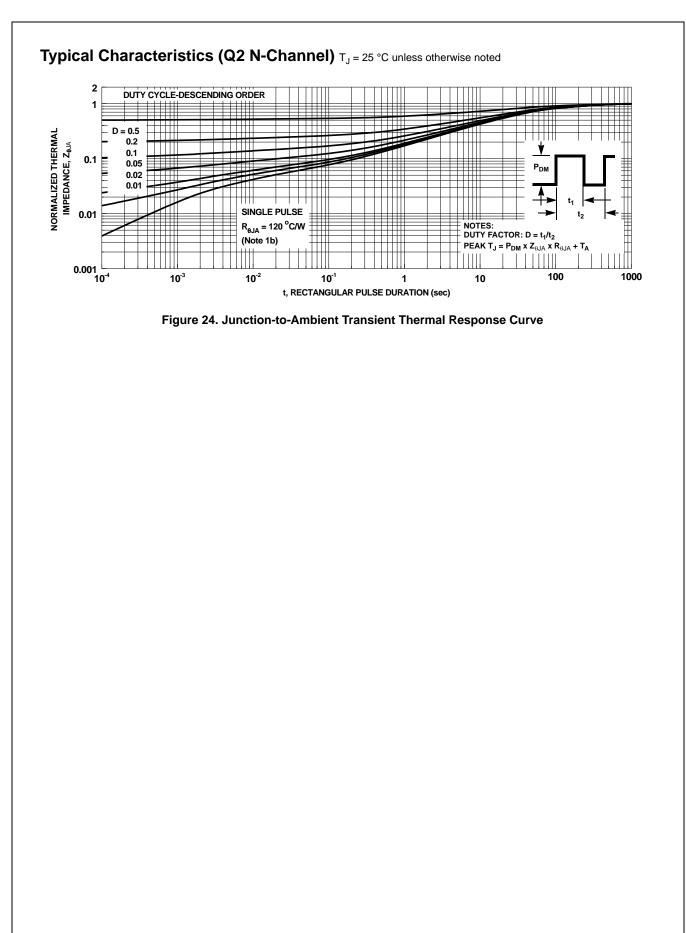












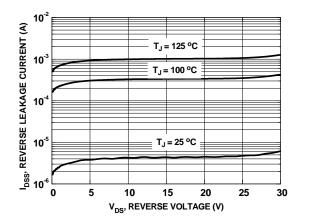
Typical Characteristics (continued)

SyncFETTM Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench[®] MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 26 shows the reverse recovery characteristic of the FDMS7620S.

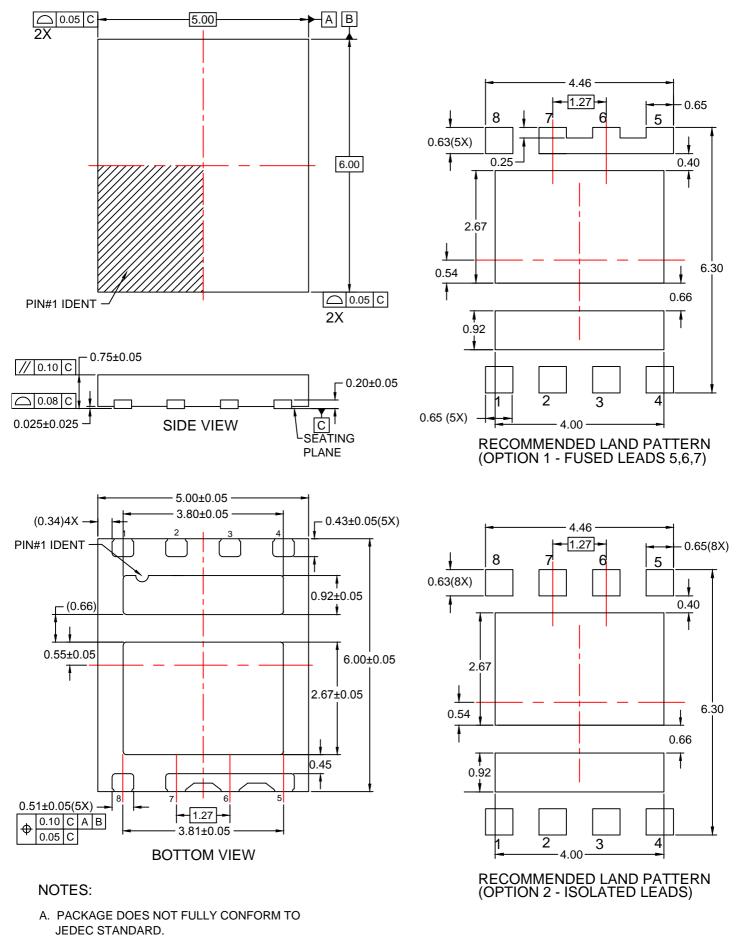
 $\begin{array}{c} 15 \\ 10 \\ 10 \\ 10 \\ 5 \\ 0 \\ -5 \\ 0 \\ 50 \\ 50 \\ 100 \\ 150 \\ 200 \\ TIME (ns) \end{array}$

Figure 25. FDMS7620S SyncFET[™] Body Diode Reverse Recovery Characteristic Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.





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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
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